

**DECLARATION
FOR UTILITY OR DESIGN
PATENT APPLICATION**

) Attorney Docket No.: 03-0171
) 81679 (6653)
) First Named Inventor:
)
) PEKIN, Senol
)
[x]Declaration []Declaration)
Submitted Submitted) Application Number: TBD
With After)
Initial Initial) Filing Date: Herewith
Filing Filing)
) Group Art Unit: not yet assigned

Examiner Name: not yet assigned

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

OPTIMIZED BOND OUT METHOD FOR FLIP CHIP WAFERS

the specification of which:

[x] is attached hereto, or
[] was filed by an authorized person on my behalf on _____ as United States Application Number _____
(Date)
or PCT International Application Number _____,
and was amended on _____ (if applicable).
(Date)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment specifically referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

Declaration 1-1297

I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT international application which designated at least on country other than the United States of America, listed below, and I have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or any PCT international application, on this invention filed by me or my legal representatives or assigns and having a filing date before that of the application on which priority is claimed:

Prior Foreign Application Number(s)	Country	Foreign Filing Date	Priority Not Claimed	Certified Copy Attached	
				Yes	No

N/A

☐ Additional foreign application numbers are listed on a supplemental priority data sheet attached hereto.

I hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional application(s) listed below:

Provisional Application Number(s)	Provisional Application Filing Date
60/490,715	7/28/03

☐ Additional provisional application numbers are listed on a supplemental priority data sheet attached hereto.

I hereby claim the benefit under Title 35, United States Code, §120, of any prior United States application(s), or under §365(c) of any PCT international application(s) designating the United States of America, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT international application(s) in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose all information known by me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56, which became available between the filing date of the prior application(s) and the national or PCT international filing date of this application:

Prior U.S. Application Number	Prior PCT International Application Number	Filing Date of U.S. or PCT International Application	Patent Number (if applicable)
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N/A

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Declaration 2-1297

As a named inventor, I hereby appoint the following registered practitioners, with full power of substitution and revocation, to prosecute this application and to transact all business in the United States Patent and Trademark Office connected therewith, and request that all correspondence and telephone calls in respect to this application be directed to:

LSI Logic Corporation
Corporate Legal Department
Intellectual Property Services Group
1621 Barber Lane, M/S D-106
Milpitas, CA 95035
Telephone 408-433-8708; FAX 408-433-7770

and I hereby further appoint:

Sandeep Jaggi	43,331
Leo J. Peters	33,562
Timothy R. Croll	36,771
Peter R. Scott	33,279

Whose address is: LSI LOGIC CORPORATION, 1621 Barber Lane, Milpitas, CA 95035; Telephone No. (408) 433-8000

and I hereby further appoint:

<u>Registered Practitioner</u>	<u>Reg.No.</u>	<u>Registered Practitioner</u>	<u>Reg.No.</u>
Morgan L. Fitch, Jr.	17,023	Robert J. Fox	27,635
Francis A. Even	16,880	Kenneth H. Samples	25,747
Julius Tabin	16,754	Philip T. Petti	31,651
John F. Flannery	19,759	Bruce R. Mansfield	29,086
Robert B. Jones	20,135	Richard A. Kaba	30,562
James J. Schumann	20,856	Karl R. Fink	34,161
James J. Hamill	19,958	Thomas F. Lebens	38,221
Timothy E. Levstik	30,192	Richard E. Wawrzyniak	36,048
Joseph E. Shipley	31,137	Scott J. Menghini	42,880

I hereby declare that all statements made herein of my own knowledge are true, and that all statements made herein on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity or enforceability of the application or any patent issued thereon.

Declaration 3-1297

Full name of sole or one
joint inventor:

Atila Mertol
(Given names first, with Family name last)

Inventor's signature:

Date:

Residence:

Cupertino, California
(City and State for U.S. Residents;
City and Country for others)

Post Office Address:

22054 Baxley Court
Cupertino, CA 95014

Citizenship:

United States

Full name of sole or one
joint inventor (NONSIGNING
INVENTOR-COMPLETED ON ADDED
PAGE):

Wilson Choi
(Given names first, with Family name last)

Inventor's signature:

Date:

Residence:

San Jose, California
(City and State for U.S. Residents;
City and Country for others)

Post Office Address:

1653 Kirk Court
San Jose, CA 95124

Citizenship:

United States

ADDED PAGE TO COMBINED DECLARATION
AND POWER OF ATTORNEY FOR SIGNATURE BY JOINT INVENTOR(S)
ON BEHALF OF NONSIGNING INVENTOR(S) WHO REFUSE(S)
TO SIGN OR CANNOT BE REACHED (37 CFR §1.47(a))

Warning: "37 C.F.R. § 1.47(a) and 35 U.S.C. § 116 ¶ 2 require all available inventors to file an application 'on behalf' of themselves and on behalf of a joint inventor who 'cannot' be found or reached after diligent effort" "or who refuses to 'join in an application.'" M.P.E.P. § 409.03(a), 6th ed., rev.3 (emphasis added). See also 62 Fed. Reg. 53,131, 53,137, 203 O.G. 68 (Oct. 10, 1997).

I. I am an above named joint inventor and have signed this declaration on my own behalf and also sign this declaration under 37 C.F.R. 1.47(a) on behalf of the nonsigning joint inventor, particulars for whom are:

Full name of (first, second, etc.) Senol Pekin
nonsigning inventor who

☒ [X] refuses to sign
☐ [] cannot be found or reached

Note: The name of the nonsigning inventor(s) should preferably also be filled in at the appropriate prior space in the declaration, adding the words "nonsigning inventor-completed on added page."

Turkey
Country of Citizenship of nonsigning inventor

950 Meridian Avenue, Apt. 72, San Jose, CA 95126
Last known address of nonsigning inventor

Note: Ordinarily, the last known address will be the last known residence of the nonsigning inventor(s). A post office box is insufficient. Other addresses at which the nonsigning inventor(s) may be reached should also be given. These can best be given in the Statement of Facts in Support of Filing on Behalf of Omitted Inventor. MPEP § 409.03(e), 6th ed.

II. Accompanying this declaration is:

- (1) A STATEMENT OF FACTS IN SUPPORT OF FILING ON BEHALF OF
NONSIGNING INVENTOR
(2) THE PETITION FEE OF \$130.00 (37 CFR 1.17(i))

<u>Atila Mertol</u>	_____	_____
Name of joint inventor	Signature	Date
signing on behalf		
of nonsigning inventor		

<u>Wilson Choi</u>	<u>Wilson Choi</u>	<u>1-6-2004</u>
Name of joint inventor	Signature	Date
signing on behalf		
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<u>Prior Foreign</u> <u>Application</u> <u>Number(s)</u>	<u>Country</u>	<u>Foreign</u> <u>Filing Date</u>	<u>Priority</u> <u>Not Claimed</u>	<u>Certified</u> <u>Copy Attached</u> <u>Yes</u> <u>No</u>
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N/A

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(Given names first, with Family name last)

Inventor's signature:

Atila Mertol

Date:

12/11/03

Residence:

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PAGE):

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(Given names first, with Family name last)

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Signature

12/11/02
Date

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